

SEMITRANS[®] 3

Ultra Fast IGBT Modules

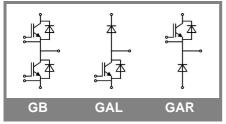
SKM 400GB125D **SKM 400GAL125D SKM 400GAR125D**

Features

- · Low inductance case
- Short tail current with low temperature dependence
- · High short circuit capability, self limiting to 6 x I_{cnom}
 • Fast & soft inverse CAL diodes
- Isolated copper baseplate using **DBC** Direct Copper Bonding Technology
- · Large clearance (13 mm) and creepage distances (20 mm)

Typical Applications*

- Switched mode power supplies at $f_{sw} > 20kHz$
- Resonant inverters up to 100 kHz
- Inductive heating
- Electronic welders at f_{sw} > 20 kHz



Absolute	: 25 °C, unless otherwise sp	pecified		
Symbol	Conditions		Values	Units
IGBT				
V_{CES}	$T_j = 25 ^{\circ}\text{C}$ $T_i = 150 ^{\circ}\text{C}$		1200	V
I _C	T _j = 150 °C	T _{case} = 25 °C	400	Α
		T _{case} = 80 °C	300	Α
I _{CRM}	I _{CRM} =2xI _{Cnom}		600	Α
V_{GES}			± 20	٧
t _{psc}	V_{CC} = 600 V; $V_{GE} \le 20$ V; $V_{CES} < 1200$ V	T _j = 125 °C	10	μs
Inverse D	Diode			
I _F	T _j = 150 °C	$T_{case} = 25 ^{\circ}C$	390	Α
		T _{case} = 80 °C	260	Α
I_{FRM}	I _{FRM} =2xI _{Fnom}		600	Α
I _{FSM}	$t_p = 10 \text{ ms; sin.}$	T _j = 150 °C	2880	Α
Freewhee	eling Diode			
I _F	T _j = 150 °C	$T_{case} = 25 ^{\circ}C$	390	Α
		T _{case} = 80 °C	260	Α
I _{FRM}	I _{FRM} =2xI _{Fnom}		600	Α
I _{FSM}	$t_p = 10 \text{ ms; sin.}$	T _j = 150 °C	2880	Α
Module				
$I_{t(RMS)}$			500	Α
T _{vj}			- 40+ 150	°C
T _{stg}			- 40+ 125	°C
V _{isol}	AC, 1 min.		4000	V

Characteristics $T_c = 25$				25 °C, unless otherwise specified		
Symbol	Conditions		min.	typ.	max.	Units
IGBT						_
$V_{\text{GE(th)}}$	$V_{GE} = V_{CE}$, $I_C = 12 \text{ mA}$		4,5	5,5	6,5	V
I _{CES}	$V_{GE} = 0 V, V_{CE} = V_{CES}$	T _j = 25 °C		0,15	0,45	mA
V _{CE0}		T _j = 25 °C		1,4		V
		T _j = 125 °C		1,7		V
r _{CE}	V _{GE} = 15 V	T _j = 25°C		6,3		mΩ
		T _j = 125°C		7,6		mΩ
V _{CE(sat)}	I _{Cnom} = 300 A, V _{GE} = 15 V	T _j = 25°C _{chiplev.}		3,3	3,85	V
		$T_j = 125^{\circ}C_{chiplev.}$		4	4,55	V
C _{ies}				22	30	nF
C _{oes}	$V_{CE} = 25, V_{GE} = 0 V$	f = 1 MHz		3,3	4	nF
C _{res}				1,2	1,6	nF
Q_G	V _{GE} = 0V - +20V			2650		nC
R _{Gint}	T _j = °C			1,25		Ω
t _{d(on)}				70		ns
t _r	$R_{Gon} = 2 \Omega$	V _{CC} = 600V		50		ns
E _{on}		I _C = 300A		17		mJ
t _{d(off)}	$R_{Goff} = 2 \Omega$	T _j = 125 °C		500 32		ns
t _f E _{off}		V _{GE} = ±15V		32 18		ns mJ
R _{th(j-c)}	per IGBT				0,05	K/W



Ultra Fast IGBT Modules

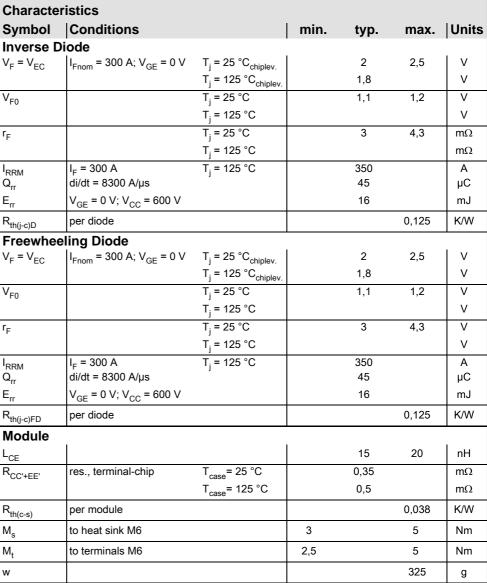
SKM 400GB125D SKM 400GAL125D SKM 400GAR125D

Features

- Low inductance case
- Short tail current with low temperature dependence
- High short circuit capability, self limiting to 6 x I_{cnom}
- Fast & soft inverse CAL diodes
- Isolated copper baseplate using DBC Direct Copper Bonding Technology
- Large clearance (13 mm) and creepage distances (20 mm)

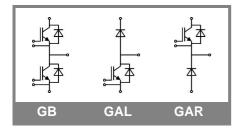
Typical Applications*

- Switched mode power supplies at f_{sw} >20kHz
- Resonant inverters up to 100 kHz
- Inductive heating
- Electronic welders at f_{sw} > 20 kHz



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.





Ultra Fast IGBT Modules

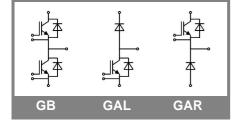
SKM 400GB125D **SKM 400GAL125D SKM 400GAR125D**

	4	
rea	ltu	res

- Low inductance case
- Short tail current with low temperature dependence
- · High short circuit capability, self limiting to 6 x I_{cnom}
 • Fast & soft inverse CAL diodes
- Isolated copper baseplate using **DBC** Direct Copper Bonding Technology
- · Large clearance (13 mm) and creepage distances (20 mm)

Typical Applications*

- Switched mode power supplies at $f_{sw} > 20kHz$
- Resonant inverters up to 100 kHz
- Inductive heating
- Electronic welders at f_{sw} > 20 kHz



Z _{th} Symbol	Conditions	Values	Units
Z,,,,,,,,,,			
Z R _i	i = 1	36	mk/W
R _i	i = 2	10,5	mk/W
R _i	i = 3	3	mk/W
R _i	i = 4	0,5	mk/W
tau _i	i = 1	0,0744	s
tau _i	i = 2	0,0078	s
tau _i	i = 3	0,0016	s
tau _i	i = 4	0,0002	s
Z _{th(j-c)D}			
R _i	i = 1	75	mk/W
R_{i}	i = 2	38	mk/W
R_{i}	i = 3	10,6	mk/W
Ri	i = 4	1,4	mk/W
tau _i	i = 1	0,0386	S
tau _i	i = 2	0,0201	s
tau _i	i = 3	0,001	S
tau _i	i = 4	0,003	s

